

# LEXI-R422

## Ultra-small LTE-M / NB-IoT / EGPRS module

**Data sheet** 



#### Abstract

Technical data sheet describing the ultra-small LEXI-R422 modules, a complete and cost-efficient solution offering multi-band LTE-M / NB-IoT / EGPRS data transmissions for low power wide area solutions in the ultra-compact LEXI form factor.



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## **Document information**

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| Functional sample                | Draft                        | For functional testing. Revised and supplementary data will be published later.        |
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| Initial production               | Early production information | Data from product verification. Revised and supplementary data may be published later. |
| Mass production /<br>End of life | Production information       | Document contains the final product specification.                                     |

#### This document applies to the following products:

| Product name | Type number      | Firmware version                    | Notification reference | Product status     |  |  |  |  |
|--------------|------------------|-------------------------------------|------------------------|--------------------|--|--|--|--|
| LEXI-R422    | LEXI-R422-01B-00 | Modem: 01.25<br>Application: A01.12 | UBXDOC-686885345-2013  | Initial production |  |  |  |  |

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## 1 Functional description

### 1.1 Overview

LEXI-R422 is an LTE Cat M1/LTE Cat NB2/EGPRS module available in the ultra-small LEXI LGA form factor (16 x 16 mm, 133-pin), with software-based multi-band configurability enabling international multi-regional coverage in LTE-M, NB-IoT and 2G radio access technologies.

The LEXI-R422 modules offer data communications over an extended operating temperature range of –40 °C to +85 °C, with low power consumption, and with coverage enhancement for deeper range into buildings and basements (and underground with NB2).

Furthermore, the LEXI-R422 modules support a comprehensive set of 3GPP Release 14 features for LTE Cat M1 and Cat NB2 that are relevant for IoT applications.

Measuring just 16 x 16 mm, LEXI-R422 modules are ideal for size-constrained devices like people and animal wearables, small asset trackers, portable healthcare systems and other small IoT applications.

With many interface options and an integrated IP stack, LEXI-R422 modules are the optimal choice for LPWA applications with low to medium data throughput rates, as well as devices that require long battery lifetimes, such as used in smart metering, smart lighting, telematics, asset tracking, remote monitoring, alarm panels, and connected healthcare.

Customers can future-proof their solutions by over-the-air firmware updates, thanks to the uFOTA client/server solution that utilizes LwM2M, a light and compact protocol ideal for IoT.

| Model     | Region | I            | RAT           |                | Pos                      | itior                            | ning                            |               |           | lox<br>ice |             |       | Inte                                | ərfa | ace | es    |                     |                                      |                        |                                    |                        |                    | Fe                 | atı                         | ıre                                 | s                                     |                        |               |           |                   |                           | Gr       | ade          | )          |
|-----------|--------|--------------|---------------|----------------|--------------------------|----------------------------------|---------------------------------|---------------|-----------|------------|-------------|-------|-------------------------------------|------|-----|-------|---------------------|--------------------------------------|------------------------|------------------------------------|------------------------|--------------------|--------------------|-----------------------------|-------------------------------------|---------------------------------------|------------------------|---------------|-----------|-------------------|---------------------------|----------|--------------|------------|
|           |        | LTE category | LTE FDD bands | (E)GPRS 4-band | Integrated GNSS receiver | Dedicated GNSS antenna interface | External GNSS control via modem | MQTT Anywhere | MQTT Flex | AssistNow  | CellLocate® | UARTs | USB (for FW update and diagnostics) |      | SIM | GPIOs | Digital audio (I2S) | Secure boot, updates, and production | Antenna dynamic tuning | Ultra-low power consumption in PSM | Embedded TCP/UDP stack | Embedded HTTP, FTP | Embedded TLS, DTLS | FW update via serial (FOAT) | u-blox Firmware update Over the Air | LwM2M with dynamically loaded objects | Embedded MQTT, MQTT-SN | Embedded CoAP | Last gasp | Jamming detection | Antenna and SIM detection | Standard | Professional | Automotive |
| LEXI-R422 | Global | M1<br>NB2    | *             | •              |                          |                                  | •                               | •             | •         | •          | •           | •     | •                                   | •    | •   | •     |                     | •                                    | •                      | •                                  | •                      | •                  | •                  | •                           | •                                   | •                                     | •                      | •             | •         | •                 | •                         |          | •            |            |

## 1.2 Product features

 $^{\ast}$  = LTE bands 1, 2, 3, 4, 5, 8, 12, 13, 18, 19, 20, 25, 26, 28, 66, 85

Table 1: LEXI-R422 main features summary



## 1.3 Block diagram

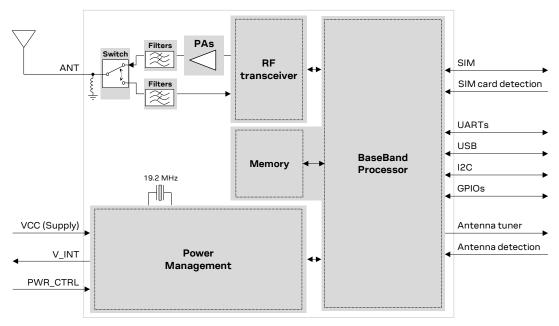


Figure 1: LEXI-R422 block diagram

## 1.4 Product description

| Item                    | LTE                                       | 2G  |
|-------------------------|---|---|
| Protocol stack          | 3GPP Release 14                           | 3GPP Release 9  |
| Radio Access Technology | LTE Cat M1 Half-Duplex                    | 2G GPRS / EGPRS TDMA  |
|                         | LTE Cat NB2 Half-Duplex                   |   |
| Operating bands         | LTE FDD band 1 (2100 MHz)                 | GSM 850 MHz   |
|                         | LTE FDD band 2 (1900 MHz)                 | E-GSM 900 MHz   |
|                         | LTE FDD band 3 (1800 MHz)                 | DCS 1800 MHz  |
|                         | LTE FDD band 4 (1700 MHz)                 | PCS 1900 MHz  |
|                         | LTE FDD band 5 (850 MHz)                  |   |
|                         | LTE FDD band 8 (900 MHz)                  |   |
|                         | LTE FDD band 12 (700 MHz)                 |   |
|                         | LTE FDD band 13 (750 MHz)                 |   |
|                         | LTE FDD band 18 (850 MHz)                 |   |
|                         | LTE FDD band 19 (850 MHz)                 |   |
|                         | LTE FDD band 20 (800 MHz)                 |   |
|                         | LTE FDD band 25 (1900 MHz)                |   |
|                         | LTE FDD band 26 (850 MHz)                 |   |
|                         | LTE FDD band 28 (700 MHz)                 |   |
|                         | LTE FDD band 66 (1700 MHz)                |   |
|                         | LTE FDD band 85 (700 MHz)                 |   |
| Power class             | LTE category M1 / NB2:                    | 2G GMSK:  |
|                         | Class 3 (23 dBm)                          | Class 4 (33 dBm) in 850/900 MHz   |
|                         |   | Class 1 (30 dBm) in 1800/1900 MHz                                       |
|                         |   | 2G 8-PSK:   |
|                         |   | Class E2 (27 dBm) in 850/900 MHz,<br>Class E2 (26 dBm) in 1800/1900 MHz |
| Data rate               | LTE category M1:                          | GPRS multi-slot class 33:   |
|                         | up to 1200 kbit/s UL, up to 375 kbit/s DL | up to 85.6 kb/s UL, up to 107 kb/s DL                                   |
|                         | LTE category NB2:                         | EGPRS multi-slot class 33:  |
|                         | up to 140 kbit/s UL, up to 125 kbit/s DL  | up to 236.8 kb/s UL, up to 296 kb/s DL                                  |

Table 2: LEXI-R422 cellular main characteristics



T

## 1.5 AT command support

The LEXI-R422 module supports AT commands according to the 3GPP standards TS 27.007 [4], TS 27.005 [5], TS 27.010 [6], and the u-blox AT commands extension.

For the complete list of AT commands and their description, see the AT commands manual [1].

### **1.6 Supported features**

Table 3 lists some of the main features supported by LEXI-R422 modules.

| Feature  | Description  |
|--|--|
| Device security  | <ul> <li>Hardware-based security functions of the chipset are used to provide:</li> <li>Secure boot: guarantees software authenticity and integrity</li> <li>Secure update: supervise the secure delivery of the correct FW to the module</li> <li>Secure production: secret keys are programmed into the module using encrypted protocols and within u-blox secured manufacturing environment.</li> </ul>   |
| MQTT Anywhere,<br>MQTT Flex                                | With u-blox's communication services – MQTT Anywhere or MQTT Flex – data overhead, time spent on-the-air, and energy consumption can be reduced, thus enabling users to extend device life cycles, lower costs, and improve ROI.   |
| External GNSS control via<br>modem                         | Access to external u-blox positioning chips and modules through I2C interface.<br>This means that any host processor can control the LEXI-R422 module and the u-blox<br>positioning chip or module through a single serial port.   |
| Embedded AssistNow<br>Software                             | Embedded AssistNow Online and AssistNow Offline clients are available.   |
| CellLocate®  | Enables the estimation of device position based on the parameters of the mobile network cells visible to the specific device based on the CellLocate® database.  |
| Hybrid positioning   | Provides the module's current position using the GNSS position or the estimated position from CellLocate <sup>®</sup> , depending on which positioning method provides the best and fastest solution according to the user configuration.  |
| Antenna dynamic tuning                                     | Real-time control of an external antenna matching IC via two dedicated pins of the module according to the LTE band used by the module, configurable by dedicated AT command.  |
| Embedded TCP and UDP<br>stack                              | Embedded TCP/IP and UDP/IP stack including direct link mode for TCP and UDP sockets.<br>Sockets can be set in Direct Link mode to establish a transparent end-to-end communication<br>with an already connected TCP or UDP socket via the serial interface.  |
| HTTP, HTTPS<br>(v1.0 for +UHTTP,<br>v1.1 for LwM2M client) | Hyper-Text Transfer Protocol as well as Secure Hyper-Text Transfer Protocol (SSL encryption) functionalities are supported via AT commands.  |
| FTP, FTPS  | File Transfer Protocol as well as Secure File Transfer Protocol (SSL encryption of FTP control channel) functionalities are supported by AT commands.  |
| CoAP<br>(RFC 7252 [12])                                    | Embedded Constrained Application Protocol (CoAP) datagram-based client/server application protocol designed to easily translate from HTTP for simplified integration with the web.   |
| MQTT (v3.1.1) and<br>MQTT-SN (v1.2)                        | Embedded Message Queuing Telemetry Transport (MQTT) and MQTT for Sensor Networks (MQTT-SN) publish-subscribe messaging protocols designed for lightweight M2M communications over TCP (MQTT) or over UDP (MQTT-SN). These allow one-to-one, one-to-many and many-to-one communications over a TCP or UDP connection.   |
| LwM2M with dynamically<br>loaded objects (v1.0)            | The LwM2M is a light and compact communication protocol designed for managing IoT machine-to-machine communication between a LwM2M server and a LwM2M client located in lightweight, low power or resource-constrained LwM2M devices, with object data model. LEXI-R422 modules allow customers to configure dynamically loaded run time objects, defining necessary custom objects, creating instances of those objects as appropriate, managing module LwM2M protocol stack to interact with the LwM2M server. |
| TLS (v1.0, v1.1, v1.2, v1.3)<br>and DTLS (v1.2)            | Transport Layer Security (TLS) version 1.3 provides security for HTTP, FTP, MQTT and TCP communications.<br>Embedded Datagram Transport Layer Security (DTLS) version 1.2 provides security for CoAP, LwM2M, MQTT-SN and UDP communications.   |



| Feature  | Description   |
|--|---|
| Jamming detection                              | Detects "artificial" interference that obscures the operator's carrier entitled to give access to the radio service and automatically reports the start and stop of such conditions to the application processor that can react accordingly.  |
| Last gasp                                      | In case of power supply outage the cellular module can be configured through the +ULGASP AT command to send an alarm notification to a remote entity.   |
| Network indication                             | GPIO configured to indicate the network status: registered home network, registered roaming, data call enabled, no service. The feature can be enabled through the +UGPIOC AT command.  |
| Antenna detection                              | The <b>ANT_DET</b> pin provides antenna presence detection capability, evaluating the resistance from the <b>ANT</b> pin to GND by an external antenna detection circuit implemented on the application board. The feature can be enabled through the +UANTR AT command.  |
| BIP  | Bearer Independent Protocol for over-the-air SIM provisioning.  |
| Dual stack IPv4/IPv6                           | Capability to move between Ipv4 and dual stack network infrastructures.<br>IPv4 and IPv6 addresses can be used.   |
| Firmware update Over AT commands (FOAT)        | Firmware module update over AT command interface.   |
| Firmware update Over The<br>Air (FOTA)         | Firmware module update over the LTE air interface using FTP / HTTP.   |
| u-blox Firmware update<br>Over The Air (uFOTA) | u-blox firmware module update over the LTE air interface client/server solution using LwM2M.  |
| Power Saving Mode (PSM)                        | The Power Saving Mode (PSM) feature, defined in 3GPP Rel.13, allows further reduction of the module current consumption maximizing the amount of time a device can remain in PSM low power deep-sleep mode during periods of data inactivity.   |
| eDRX   | Extended mode DRX, based on 3GPP Rel.13, reduces the amount of signaling overhead decreasing the frequency of scheduled measurements and/or transmissions performed by the module in idle mode. This in turn leads to a reduction in the module power consumption while maintaining a perpetual connection with the base station. |
| Coverage Enhancement                           | Coverage Enhancement (CE) mode introduced in 3GPP Rel.13 are used to improve the cell signal penetration.   |
| Connected Mode Mobility                        | LTE Cat M1 Connected Mode Mobility (CMM) with CE Mode A   |
| Release Assistance<br>Indicator                | The 3GPP Release Assistance feature allows the module to request for the Radio Resource<br>Control connection to be dropped as soon as the message has been received by the network.<br>This feature allows a reduction in the module power consumption.  |
| Backup and restore                             | This feature allows the modules to autonomously restore the flash file system using the last backup stored on the module itself. For further details about the backup and restore feature, see the +UBKUPDATA AT command description in the AT commands manual [1]  |

Table 3 Main features supported by LEXI-R422 modules

u-blox is extremely mindful of user privacy. When a position is sent to the CellLocate<sup>®</sup> server, u-blox is unable to track the SIM used or the specific device.



## 2 Interfaces

### 2.1 Power management

### 2.1.1 Module supply input (VCC)

LEXI-R422 modules must be supplied through the **VCC** pins by a proper external DC power supply providing a nominal voltage within the normal operating range (see Table 11). Voltage must be stable, because during operation the current drawn from **VCC** may vary significantly, based on the power consumption profile of the LTE-M, NB-IoT and the 2G radio access technologies described in the LEXI-R422 system integration manual [2].

LEXI-R422 modules provide separate supply inputs over the three **VCC** pins:

- VCC pins A13 and A14 (number 41 and 40) are the supply input for the internal RF Power Amplifier, demanding most of the total current drawn of the module when RF transmission is enabled
- VCC pin A12 (number 42) is the supply input for the internal baseband Power Management Unit, demanding minor part of the total current drawn of the module when RF transmission is enabled

The internal baseband Power Management Unit integrates voltage regulators generating all the internal supply voltages needed by the module for its intended operations. This includes the supply voltage for the generic digital interfaces (**V\_INT**) and for the SIM interface (**VSIM**).

It is important that the system power supply circuit can withstand the maximum pulse current during a transmit burst at maximum power level (see Table 13).

#### 2.1.2 Generic digital interfaces supply output (V\_INT)

LEXI-R422 modules provide a 1.8 V supply rail output on the  $V_{INT}$  pin, which is internally generated when the module is switched on, outside the ultra-low power deep-sleep mode. The same voltage domain is used internally to supply the generic digital interfaces of the module. The  $V_{INT}$  supply output can be used in place of an external discrete regulator.

It is recommended to provide accessible test points directly connected to the **V\_INT** pin.

### 2.2 Antenna interfaces

#### 2.2.1 Cellular antenna RF interface (ANT)

The **ANT** pin is the cellular RF antenna I/O interface, designed with 50  $\Omega$  characteristic impedance.

#### 2.2.2 Cellular antenna detection (ANT\_DET)

The **ANT\_DET** pin is an analog to digital converter (ADC) input with a current source provided by the LEXI-R422 modules to sense the presence of the external cellular antenna (as an optional feature), evaluating the DC resistance to GND by an externally implemented circuit. For more details, see the system integration manual [2] and the AT commands manual [1].

### 2.3 System functions

#### 2.3.1 Module power-on

When the LEXI-R422 modules are not powered, they can be switched on as following:

• Applying a voltage at the VCC module supply input within the operating range (see Table 11), and then forcing a low level at the **PWR\_CTRL** input pin, which is normally set high by an internal pull-up, for a valid time period (see section 4.2.8, module switch on).



When the modules are in power-off mode (i.e. switched off, but with a valid voltage present at the **VCC** supply input within the operating range reported in Table 11), they can be switched on as follows:

• Forcing a low level at the **PWR\_CTRL** input pin, which is normally set high by an internal pull-up, for a valid time period (see section 4.2.8, module switch on).

When the modules are in low power PSM / eDRX deep-sleep mode, with a valid voltage present at the **VCC** supply input within the operating range reported in Table 11, they can be woken up as follows:

• Forcing a low level at the **PWR\_CTRL** input pin, which is normally set high by an internal pull-up, for a valid time period (see section 4.2.8, module wake-up from PSM / eDRX deep-sleep).

The **PWR\_CTRL** line is intended to be driven by open drain, open collector or contact switch.

It is recommended to provide accessible test points directly connected to the **PWR\_CTRL** pin.

#### 2.3.2 Module power-off

The proper graceful power-off procedure of the LEXI-R422 modules, with storage of the current parameter settings in module's non-volatile memory and a clean network detach, can be triggered by:

- AT+CPWROFF command
- Forcing a low pulse at the **PWR\_CTRL** input pin, for a valid time period (see section 4.2.8, module graceful switch-off)

A faster emergency power-off procedure of LEXI-R422, with storage of current parameter settings in the module's non-volatile memory, but without a clean network detach, can be triggered by:

- AT+CFUN=10 command
- Forcing a rising edge at the GPIO input pin configured with the faster power-off function (see section 2.6, faster power-off)

The fastest memory-safe emergency power-off procedure of LEXI-R422, inhibiting further operations in the non-volatile flash memory, without executing the storage of the current parameter settings, and without executing a clean network detach, can be triggered by:

- AT+CFUN=11 command
- Forcing a rising edge at the GPIO input pin configured with the memory-safe power-off function (see section 2.6, memory-safe power-off)

An abrupt under-voltage shutdown occurs on the LEXI-R422 when the **VCC** voltage supply is removed. If this event occurs, it is not possible to store the current parameter settings in the module's non-volatile memory or to perform a clean network detach.

LEXI-R422 modules automatically switch off, with storage of the current parameter settings in the module's internal non-volatile memory and a clean network detach, after having sent the last gasp, once the feature is enabled and triggered by the +ULGASP AT command.

#### 2.3.3 Module reset

LEXI-R422 modules can be reset (rebooted), performing storage of the current parameter settings in module's non-volatile memory and a clean network detach before the reboot, by:

• AT+CFUN=16 command

An abrupt emergency reset (reboot) is triggered on LEXI-R422 modules, without storage of current parameter settings and without a clean network detach, when:

• A low level is applied on the **PWR\_CTRL** pin for a valid time period (see section 4.2.8, module abrupt emergency reset / reboot).



## 2.4 SIM

#### 2.4.1 SIM interface

LEXI-R422 modules provide an interface on the VSIM, SIM\_IO, SIM\_CLK, SIM\_RST pins to connect an external SIM card/chip. Only the 1.8 V SIM card/chip types are supported. Activation and deactivation are implemented according to the ISO-IEC 7816-3 specifications.

#### 2.4.2 SIM detection

The **GPIO6** pin of LEXI-R422 modules is a 1.8 V digital input which can be configured as an external interrupt to detect the SIM card presence (as a feature which can be optionally used), as intended to be properly connected to the mechanical switch of an external SIM card holder.

For more details see the LEXI-R422 system integration manual [2] and the AT commands manual [1], +UGPIOC, +CIND, +CMER, and +UDCFONF=50 AT commands.

### 2.5 Serial communication

The LEXI-R422 module provides the following serial communication interfaces:

- UART interfaces, for communications with host application processor (section 2.5.1)
- USB 2.0 interface, for FW update and/or diagnostics only (section 2.5.2)
- I2C bus compatible interface, for communications with external I2C devices (section 2.5.3)

### 2.5.1 UART interfaces

LEXI-R422 modules include a primary UART interface (UART) for communication with an application host processor, supporting AT commands, data communication, multiplexer protocol functionality, FW update by FOAT, with settings configurable by dedicated AT commands

- 8-wire serial port with RS-232 functionality conforming to ITU-T V.24 recommendation [9], with CMOS compatible signal levels (0 V for low data bit / ON state, 1.8 V for high data bit / OFF state)
  - $\circ$   $\,$  Data lines (RXD as data output, TXD as data input)
  - HW flow control lines (CTS as flow control output, RTS as flow control input)
  - Modem status and control lines (DTR input, DSR output, DCD output, RI output)<sup>1</sup>
- The default baud rate is 115200 b/s
- The default frame format is 8N1 (8 data bits, no parity, 1 stop bit)
- The UART is available only if the USB is not enabled as an AT command / data communication interface: UART and USB cannot be concurrently used for this purpose.

LEXI-R422 modules include a second auxiliary UART interface (UART AUX) for communication with an application host processor, supporting AT commands, data, GNSS tunneling, FW update by FOAT, with settings configurable by dedicated AT commands

- 4-wire serial port with RS-232 functionality conforming to ITU-T V.24 recommendation [9], with CMOS compatible signal levels (0 V for low data bit / ON state, 1.8 V for high data bit / OFF state)
  - Data lines (DCD as data output, DTR as data input)
  - $\circ$  HW flow control lines (**RI** as flow control output, **DSR** as flow control input)
- The default baud rate is 115200 b/s
- The default frame format is 8N1 (8 data bits, no parity, 1 stop bit)

<sup>&</sup>lt;sup>1</sup> DTR, DSR, DCD and RI pins can be alternatively configured, in a mutually exclusive way, as secondary auxiliary UART interface.



#### 2.5.1.1 Multiplexer protocol

LEXI-R422 modules include multiplexer functionality as per 3GPP TS 27.010 [6] on the primary UART interface physical link. This is a data link protocol usings HDLC-like framing between the module (DCE) and the application processor (DTE), allowing simultaneous sessions over the primary UART.

#### 2.5.2 USB interface

LEXI-R422 modules include a USB 2.0 interface [10], acting as USB device, with the following lines:

- The USB\_D+ / USB\_D- lines, carrying the USB data and signaling
- The USB\_5V0 input pin to enable the USB interface by applying an external voltage (5.0 V typical)
- The USB\_3V3 input pin to supply the USB interface by applying an external 3.3 V typical voltage

The USB interface is available for FW upgrade by u-blox EasyFlash tool and for diagnostic purposes only: AT commands and data communication are not supported via USB interface.

It is highly recommended to provide accessible test points directly connected to the USB interface pins (USB\_5V0, USB\_3V3, USB\_D+, USB\_D-), as well as to the V\_INT, PWR\_CTRL, RSVD #99 pins, for FW update and for diagnostic purposes.

#### 2.5.3 I2C interface

LEXI-R422 modules include a 1.8V I2C-bus compatible interface over the **SDA** and **SCL** pins, available to communicate with an external u-blox GNSS receiver and/or with compatible external I2C devices: the LEXI-R422 module acts as an I2C host that can communicate with I2C devices in accordance with the I2C bus specifications [11].

## 2.6 GPIO

LEXI-R422 modules include pins that can be configured as general-purpose input/output or to provide custom functions as summarized in Table 4. For further details, see LEXI-R422 system integration manual [2] and the GPIO section of the AT commands manual [1].

| Function                    | Description  | Default GPIO | Configurable GPIOs   |
|-----------------------------|--|--------------|--|
| General purpose<br>output   | Output to set the high or the low digital level  |              | GPIO1, GPIO2, GPIO3,<br>GPIO4, GPIO5,<br>RFCTRL1, RFCTRL2        |
| General purpose<br>input    | Input to sense high or low digital level   |              | GPIO1, GPIO2, GPIO3,<br>GPIO4, GPIO5, GPIO6,<br>RFCTRL1, RFCTRL2 |
| Network status indication   | Output indicating cellular network status: registered, data transmission, no service                           |              | GPIO1  |
| External GNSS supply enable | Output to enable/disable the supply of an external u-blox<br>GNSS receiver connected to the module by I2C      |              | GPIO2  |
| External GNSS<br>data ready | Input to sense when an external u-blox GNSS receiver connected to the module is ready to send data over I2C    |              | GPIO3  |
| SIM card<br>detection       | Input for SIM card physical presence detection   |              | GPIO6  |
| Ring indicator              | Output providing events indicator  |              | RI   |
| Module status indication    | Output indicating module status: power-off or deep-sleep mode versus idle, active or connected mode            |              | GPIO1, GPIO2, GPIO3,<br>GPIO4, GPIO5, GPIO6                      |
| Last gasp                   | Input to trigger last gasp notification  |              | GPIO3, GPIO4, GPIO5  |
| Faster power-off            | Input with internal pull-down to trigger a faster emergency shutdown (as AT+CFUN=10) by applying a rising edge |              | GPIO3, GPIO4   |



| Function                  | Description   | Default GPIO         | Configurable GPIOs  |
|---------------------------|---|----------------------|---|
| Safe memory<br>power-off  | Input with internal pull-down to trigger the fastest<br>memory-safe emergency shutdown (as AT+CFUN=11) by<br>applying a rising edge |                      | GPIO3, GPIO4  |
| LwM2M pulse               | Output to notify a settable LwM2M event with a<br>configurable pulse  |                      | GPIO1, GPIO2, GPIO3,<br>GPIO4, GPIO5, GPIO6                             |
| Antenna<br>dynamic tuning | Output changing the status according to the RF band in use, to control in real time an external antenna tuning IC                   |                      | RFCTRL1, RFCTRL2  |
| Pin disabled              | Tri-state with an internal active pull-down enabled   | GPIO4, GPIO5, GPIO6, | GPIO1, GPIO2, GPIO3,<br>GPIO4, GPIO5, GPIO6,<br>RFCTRL1, RFCTRL2,<br>RI |

Table 4: GPIO custom functions configuration

## 2.7 Cellular antenna dynamic tuner interface

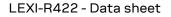
LEXI-R422 modules include two output pins (named **RFCTRL1** and **RFCTRL2**) that can optionally be used to control in real time an external antenna tuning IC, as the two pins change their output value dynamically according to the specific current LTE/2G band in use by the module. Table 5 illustrates the default factory-programmed configuration that can be changed by dedicated AT command.

| RFCTRL1 | RFCTRL2 | LTE frequency band in use               | 2G frequency band in use       |
|---------|---------|---|--------------------------------|
| 0       | 0       |   |                                |
| 0       | 1       | B12, B13, B28, B85 (700800 MHz)         |                                |
| 1       | 0       | B5, B8, B18, B19, B20, B26 (800900 MHz) | GSM 850, E-GSM 900(800900 MHz) |
| 1       | 1       | B1, B2, B3, B4, B25, B66 ( > 1000 MHz)  | DCS 1800, PCS 1900(> 1000 MHz) |

Table 5: LEXI-R422 modules antenna dynamic tuning truth table (default factory-programmed configuration)

## 2.8 Reserved pin (RSVD)

LEXI-R422 modules include pins reserved for future use, marked as **RSVD**, which can all be left unconnected on the application board, except for the **RSVD** pin number **99** (also identified as **J5**), which is recommended to be externally accessible by connecting it to a dedicated Test-Point.





## 3 Pin definition

## 3.1 Pin assignment

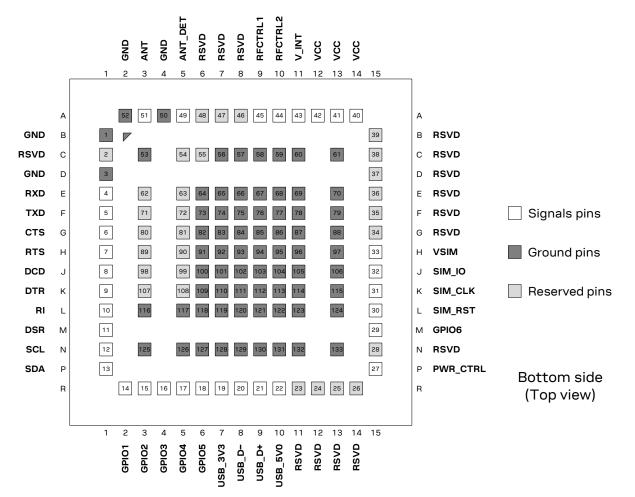


Figure 2: LEXI-R422 module pin assignment (top view)

| ID | No | Name    | Power<br>domain | I/O | Description                            | Remarks  |
|----|----|---------|-----------------|-----|--|--|
| A2 | 52 | GND     | -               | N/A | Ground                                 | All the GND pins must be connected to ground.  |
| A3 | 51 | ANT     | -               | I/O | Cellular antenna                       | RF input/output for cellular Rx/Tx antenna. 50 $\Omega$ nominal impedance.   |
|    |    |         |                 |     |  | See section 2.2.1 and 4.2.5 / 4.2.6 for details.   |
| A4 | 50 | GND     | -               | N/A | Ground                                 | All the GND pins must be connected to ground.  |
| A5 | 49 | ANT_DET | ADC             | I   | Antenna detection                      | Antenna presence detection function.<br>See section 2.2.2 for functional description.<br>See section 4.2.7 for detailed electrical specs.  |
| A6 | 48 | RSVD    | -               | N/A | Reserved pin                           | Leave unconnected.   |
| A7 | 47 | RSVD    | -               | N/A | Reserved pin                           | Leave unconnected.   |
| A8 | 46 | RSVD    | -               | N/A | Reserved pin                           | Leave unconnected.   |
| A9 | 45 | RFCTRL1 | GDI             | 0   | RF GPIO for cellular<br>antenna tuning | Digital output to optionally control an antenna tuning IC.<br>Push-pull output type.<br>See section 2.6 / 2.7 for functional description.<br>See section 4.2.11 for detailed electrical specs. |



| ID  | No | Name    | Power<br>domain | I/O | Description  | Remarks   |  |  |
|-----|----|---------|-----------------|-----|--|---|--|--|
| A10 | 44 | RFCTRL2 | GDI             | 0   | RF GPIO for cellular<br>antenna tuning   | Digital output to optionally control an antenna tuning IC.<br>Push-pull output type.<br>See section 2.6 / 2.7 for functional description.<br>See section 4.2.11 for detailed electrical specs.  |  |  |
| A11 | 43 | V_INT   | -               | 0   | Generic Digital<br>Interfaces supply<br>output   | V_INT = 1.8 V (typical) supply generated by the module when<br>is switched on, outside low power deep sleep mode.<br>See section 2.1.2 for functional description.<br>See section 4.2.3 for detailed electrical specs.<br>Provide test point for diagnostic purposes. |  |  |
| A12 | 42 | VCC     | -               | I   | Module supply input  | All VCC pins must be connected to external supply.<br>Supply input for internal Power Management Unit<br>See section 2.1.1 for functional description.<br>See section 4.2.3 and 4.2.4 for detailed electrical specs.  |  |  |
| A13 | 41 | VCC     | -               | Ι   | outputSee section 2.1.2 for functional description.<br>See section 4.2.3 for detailed electrical specs.<br>Provide test point for diagnostic purposes.Module supply inputAll VCC pins must be connected to external supply<br>Supply input for internal Power Management Unit<br>See section 2.1.1 for functional description.<br>See section 4.2.3 and 4.2.4 for detailed electrical sModule supply inputAll VCC pins must be connected to external supply<br>Supply input for internal RF Power Amplifiers.<br>See section 2.1.1 for functional description.<br>See section 4.2.3 and 4.2.4 for detailed electrical section 4.2.3 and 4.2.4 for detailed el |   |  |  |
| A14 | 40 | VCC     | -               | I   | Module supply input  |   |  |  |
| В1  | 1  | GND     | -               | N/A | Ground   | All the GND pins must be connected to ground.   |  |  |
| B15 | 39 | RSVD    | -               | N/A | Reserved pin   | Leave unconnected.  |  |  |
| C1  | 2  | RSVD    | -               | N/A | Reserved pin   | Leave unconnected.  |  |  |
| СЗ  | 53 | GND     | -               | N/A | Ground   | All the GND pins must be connected to ground.   |  |  |
| C5  | 54 | RSVD    | -               | N/A | Reserved pin   | Leave unconnected.  |  |  |
| C6  | 55 | RSVD    | -               | N/A | Reserved pin   | Leave unconnected.  |  |  |
| C7  | 56 | GND     | -               | N/A | Ground   | All the GND pins must be connected to ground.   |  |  |
| C8  | 57 | GND     | -               | N/A | Ground   | All the GND pins must be connected to ground.   |  |  |
| C9  | 58 | GND     | -               | N/A | Ground   | All the GND pins must be connected to ground.   |  |  |
| C10 | 59 | GND     | -               | N/A | Ground   | All the GND pins must be connected to ground.   |  |  |
| C11 | 60 | GND     | -               | N/A | Ground   | All the GND pins must be connected to ground.   |  |  |
| C13 | 61 | GND     | -               | N/A | Ground   | All the GND pins must be connected to ground.   |  |  |
| C15 | 38 | RSVD    | -               | N/A | Reserved pin   | Leave unconnected.  |  |  |
| D1  | 3  | GND     | -               | N/A | Ground   | All the GND pins must be connected to ground.   |  |  |
| D15 | 37 | RSVD    | -               | N/A | Reserved pin   | Leave unconnected.  |  |  |
| E1  | 4  | RXD     | GDI             | 0   | UART data output   | <b>U</b>  |  |  |
| E3  | 62 | RSVD    | -               | N/A | Reserved pin   | Leave unconnected.  |  |  |
| E5  | 63 | RSVD    | -               | N/A | Reserved pin   | Leave unconnected.  |  |  |
| E6  | 64 | GND     | -               | N/A | Ground   | All the GND pins must be connected to ground.   |  |  |
| E7  | 65 | GND     | -               | N/A | Ground   | All the GND pins must be connected to ground.   |  |  |
| E8  | 66 | GND     | -               | N/A | Ground   | All the GND pins must be connected to ground.   |  |  |
| E9  | 67 | GND     | -               | N/A | Ground   | All the GND pins must be connected to ground.   |  |  |
| E10 | 68 | GND     | -               | N/A | Ground   | All the GND pins must be connected to ground.   |  |  |
| E11 | 69 | GND     | -               | N/A | Ground   | All the GND pins must be connected to ground.   |  |  |
| E13 | 70 | GND     | -               | N/A | Ground   | All the GND pins must be connected to ground.   |  |  |
|     |    |         |                 |     |  |   |  |  |



| ID  | No | Name | Power<br>domain | I/O | Description          | Remarks  |
|-----|----|------|-----------------|-----|----------------------|--|
| E15 | 36 | RSVD | -               | N/A | Reserved pin         | Leave unconnected.   |
| F1  | 5  | TXD  | GDI             | I   | UART data input      | Circuit 103 in ITU-T V.24 (TxD data input, idle high, active<br>low, with internal active pull-up enabled).<br>See section 2.5.1 for functional description.<br>See section 4.2.11 for detailed electrical specs.  |
| F3  | 71 | RSVD | -               | N/A | Reserved pin         | Leave unconnected.   |
| F5  | 72 | RSVD | -               | N/A | Reserved pin         | Leave unconnected.   |
| F6  | 73 | GND  | -               | N/A | Ground               | All the GND pins must be connected to ground.  |
| F7  | 74 | GND  | -               | N/A | Ground               | All the GND pins must be connected to ground.  |
| F8  | 75 | GND  | -               | N/A | Ground               | All the GND pins must be connected to ground.  |
| F9  | 76 | GND  | _               | N/A | Ground               | All the GND pins must be connected to ground.  |
| F10 | 77 | GND  | -               | N/A | Ground               | All the GND pins must be connected to ground.  |
| F11 | 78 | GND  | -               | N/A | Ground               | All the GND pins must be connected to ground.  |
| F13 | 79 | GND  | _               | N/A | Ground               | All the GND pins must be connected to ground.  |
| F15 | 35 | RSVD | -               | N/A | Reserved pin         | Leave unconnected.   |
| G1  | 6  | CTS  | GDI             | 0   | UART clear to send   | Circuit 106 in ITU-T V.24 (CTS hardware flow control output,<br>push-pull, idle high, active low).<br>See section 2.5.1 for functional description.<br>See section 4.2.11 for detailed electrical specs.   |
| G3  | 80 | RSVD | -               | N/A | Reserved pin         | Leave unconnected.   |
| G5  | 81 | RSVD | -               | N/A | Reserved pin         | Leave unconnected.   |
| G6  | 82 | GND  | -               | N/A | Ground               | All the GND pins must be connected to ground.  |
| G7  | 83 | GND  | -               | N/A | Ground               | All the GND pins must be connected to ground.  |
| G8  | 84 | GND  | -               | N/A | Ground               | All the GND pins must be connected to ground.  |
| G9  | 85 | GND  | -               | N/A | Ground               | All the GND pins must be connected to ground.  |
| G10 | 86 | GND  | -               | N/A | Ground               | All the GND pins must be connected to ground.  |
| G11 | 87 | GND  | -               | N/A | Ground               | All the GND pins must be connected to ground.  |
| G13 | 88 | GND  | -               | N/A | Ground               | All the GND pins must be connected to ground.  |
| G15 | 34 | RSVD | _               | N/A | Reserved pin         | Leave unconnected.   |
| H1  | 7  | RTS  | GDI             | I   | UART request to send | Circuit 105 in ITU-T V.24 (RTS flow control input, idle high,<br>active low, with internal active pull-up enabled).<br>See section 2.5.1 for functional description.<br>See section 4.2.11 for detailed electrical specs.  |
| НЗ  | 89 | RSVD | -               | N/A | Reserved pin         | Leave unconnected.   |
| H5  | 90 | RSVD | -               | N/A | Reserved pin         | Leave unconnected.   |
| H6  | 91 | GND  | -               | N/A | Ground               | All the GND pins must be connected to ground.  |
| H7  | 92 | GND  | -               | N/A | Ground               | All the GND pins must be connected to ground.  |
| H8  | 93 | GND  | -               | N/A | Ground               | All the GND pins must be connected to ground.  |
| H9  | 94 | GND  | -               | N/A | Ground               | All the GND pins must be connected to ground.  |
| H10 | 95 | GND  | -               | N/A | Ground               | All the GND pins must be connected to ground.  |
| H11 | 96 | GND  | -               | N/A | Ground               | All the GND pins must be connected to ground.  |
| H13 | 97 | GND  | -               | N/A | Ground               | All the GND pins must be connected to ground.  |
| H15 | 33 | VSIM | -               | 0   | SIM supply output    | VSIM = 1.8 V (typical) supply generated by the module for<br>external SIM / UICC, when it is switched on, after the internal<br>boot sequence, outside low power deep sleep mode.<br>See section 2.4.1 for functional description.<br>See section 4.2.9 for detailed electrical specs. |



| ID  | No  | Name    | Power<br>domain | I/O      | Description  | Remarks  |
|-----|-----|---------|-----------------|----------|--|--|
| J1  | 8   | DCD     | GDI             | 0/<br>0  | UART data carrier<br>detect /<br>AUX UART data<br>output | Circuit 109 in ITU-T V.24 (DCD output, push-pull, idle high,<br>active low), alternatively settable as Second Auxiliary UART<br>RXD (data output, push-pull, idle high, active low).<br>See section 2.5.1 for functional description.  |
|     |     |         |                 |          |  | See section 4.2.11 for detailed electrical specs.  |
| JЗ  | 98  | RSVD    | -               | N/A      | Reserved pin   | Leave unconnected.   |
| J5  | 99  | RSVD    | -               | N/A      | Reserved pin   | Provide test point for diagnostic purposes.  |
| J6  | 100 | GND     | -               | N/A      | Ground   | All the GND pins must be connected to ground.  |
| J7  | 101 | GND     | -               | N/A      | Ground   | All the GND pins must be connected to ground.  |
| J8  | 102 | GND     | -               | N/A      | Ground   | All the GND pins must be connected to ground.  |
| J9  | 103 | GND     | -               | N/A      | Ground   | All the GND pins must be connected to ground.  |
| J10 | 104 | GND     | -               | N/A      | Ground   | All the GND pins must be connected to ground.  |
| J11 | 105 | GND     | -               | N/A      | Ground   | All the GND pins must be connected to ground.  |
| J13 | 106 | GND     | -               | N/A      | Ground   | All the GND pins must be connected to ground.  |
| J15 | 32  | SIM_IO  | SIM             | I/O      | SIM data   | Internal pull-up resistor to VSIM.   |
|     |     |         |                 |          |  | See section 2.4.1 for functional description.  |
|     |     |         |                 |          |  | See section 4.2.9 for detailed electrical specs.   |
| К1  | 9   | DTR     | GDI             | /<br>    | UART data terminal<br>ready /<br>AUX UART data input     | Circuit 108/2 in ITU-T V. 24 (DTR input, idle high, active low,<br>with internal active pull-up enabled), alternatively settable<br>as second auxiliary UART TXD (data input, idle high, active<br>low, with internal active pull-up enabled).<br>See section 2.5.1 for functional description.<br>See section 4.2.11 for detailed electrical specs. |
| K3  | 107 | RSVD    | -               | N/A      | Reserved pin   | Leave unconnected.   |
| K5  | 108 | RSVD    | -               | N/A      | Reserved pin   | Leave unconnected.   |
| K6  | 109 | GND     | -               | N/A      | Ground   | All the GND pins must be connected to ground.  |
| K7  | 110 | GND     | -               | N/A      | Ground   | All the GND pins must be connected to ground.  |
| K8  | 111 | GND     | -               | N/A      | Ground   | All the GND pins must be connected to ground.  |
| K9  | 112 | GND     | -               | N/A      | Ground   | All the GND pins must be connected to ground.  |
| K10 | 113 | GND     | -               | N/A      | Ground   | All the GND pins must be connected to ground.  |
| K11 | 114 | GND     | -               | N/A      | Ground   | All the GND pins must be connected to ground.  |
| K13 | 115 | GND     | -               | N/A      | Ground   | All the GND pins must be connected to ground.  |
| K15 | 31  | SIM_CLK | SIM             | 0        | SIM clock  | See section 2.4.1 for functional description.<br>See section 4.2.9 for detailed electrical specs.  |
| L1  | 10  | RI      | GDI             | 0/<br>0  | UART ring indicator /<br>AUX UART clear to<br>send       | Circuit 125 in ITU-T V.24 (RI output, push-pull, idle high,<br>active low), alternatively configurable as second auxiliary<br>UART CTS (HW flow control output, push-pull, idle high,<br>active low).<br>See section 2.5.1 for functional description.<br>See section 4.2.11 for detailed electrical specs.  |
| L3  | 116 | GND     | -               | N/A      | Ground   | All the GND pins must be connected to ground.  |
| L5  | 117 | GND     | -               | N/A      | Ground   | All the GND pins must be connected to ground.  |
| L6  | 118 | GND     | -               | N/A      | Ground   | All the GND pins must be connected to ground.  |
| L7  | 119 | GND     | -               | N/A      | Ground   | All the GND pins must be connected to ground.  |
| L8  | 120 | GND     | -               | N/A      | Ground   | All the GND pins must be connected to ground.  |
| L9  | 121 | GND     | -               | N/A      | Ground   | All the GND pins must be connected to ground.  |
| L10 | 122 | GND     | -               | N/A      | Ground   | All the GND pins must be connected to ground.  |
| L11 | 123 | GND     | -               | N/A      | Ground   | All the GND pins must be connected to ground.  |
| L13 | 124 | GND     | -               | ,<br>N/A | Ground   | All the GND pins must be connected to ground.  |
| -   |     |         |                 |          |  | ,  |



| ID  | No  | Name     | Power<br>domain | I/O     | Description                   | Remarks  |
|-----|-----|----------|-----------------|---------|-------------------------------|--|
| L15 | 30  | SIM_RST  | SIM             | 0       | SIM reset                     | See section 2.4.1 for functional description.<br>See section 4.2.9 for detailed electrical specs.  |
| M1  | 11  | DSR      | GDI             | 0/<br>I | • •                           | Circuit 107 in ITU-T V.24 (DSR output, push-pull, idle high,<br>active low), alternatively configurable as second auxiliary<br>UART RTS (HW flow control input, idle high, active low, with<br>internal active pull-up enabled).<br>See section 2.5.1 for functional description.<br>See section 4.2.11 for detailed electrical specs. |
| M15 | 29  | GPIO6    | GDI             | I/O     | Pin for SIM card detection    | Configurable GPIO, alternatively configurable as input pin for<br>SIM card detection. Push-pull output type.<br>See sections 2.4.2 and 2.6 for functional description.<br>See section 4.2.11 for detailed electrical specs.  |
| N1  | 12  | SCL      | I2C             | 0       | I2C bus clock line            | Fixed open drain.<br>Internal 2.2 k $\Omega$ pull-up to V_INT. Idle high, active low.<br>See section 2.5.3 for functional description.<br>See section 4.2.10 for detailed electrical specs.  |
| N3  | 125 | GND      | -               | N/A     | Ground                        | All the GND pins must be connected to ground.  |
| N5  | 126 | GND      | -               | N/A     | Ground                        | All the GND pins must be connected to ground.  |
| N6  | 127 | GND      | -               | N/A     | Ground                        | All the GND pins must be connected to ground.  |
| N7  | 128 | GND      | -               | N/A     | Ground                        | All the GND pins must be connected to ground.  |
| N8  | 129 | GND      | -               | N/A     | Ground                        | All the GND pins must be connected to ground.  |
| N9  | 130 | GND      | -               | N/A     | Ground                        | All the GND pins must be connected to ground.  |
| N10 | 131 | GND      | -               | N/A     | Ground                        | All the GND pins must be connected to ground.  |
| N11 | 132 | GND      | -               | N/A     | Ground                        | All the GND pins must be connected to ground.  |
| N13 | 133 | GND      | -               | N/A     | Ground                        | All the GND pins must be connected to ground.  |
| N15 | 28  | RSVD     | -               | N/A     | Reserved pin                  | Leave unconnected.   |
| P1  | 13  | SDA      | I2C             | I/O     | I2C bus data line             | Fixed open drain.<br>Internal 2.2 k $\Omega$ pull-up to V_INT. Idle high, active low.<br>See section 2.5.3 for functional description.<br>See section 4.2.10 for detailed electrical specs.  |
| P15 | 27  | PWR_CTRL | POS             | I       | Power on/off control<br>input | Internal active pull-up. Active low.<br>See section 2.3.1 and 2.3.2 for functional description.<br>See section 4.2.8 for detailed electrical specs.<br>Provide test point for diagnostic purposes.   |
| R2  | 14  | GPIO1    | GDI             | I/O     | GPIO                          | Configurable GPIO. Push-pull output type.<br>See section 2.6 for functional description.<br>See section 4.2.11 for detailed electrical specs.  |
| R3  | 15  | GPIO2    | GDI             | I/O     | GPIO                          | Configurable GPIO. Push-pull output type.<br>See section 2.6 for functional description.<br>See section 4.2.11 for detailed electrical specs.  |
| R4  | 16  | GPIO3    | GDI             | I/O     | GPIO                          | Configurable GPIO. Push-pull output type.<br>See section 2.6 for functional description.<br>See section 4.2.11 for detailed electrical specs.  |
| R5  | 17  | GPIO4    | GDI             | I/O     | GPIO                          | Configurable GPIO. Push-pull output type.<br>See section 2.6 for functional description.<br>See section 4.2.11 for detailed electrical specs.  |
| R6  | 18  | GPIO5    | GDI             | I/O     | GPIO                          | Configurable GPIO. Push-pull output type.<br>See section 2.6 for functional description.<br>See section 4.2.11 for detailed electrical specs.  |



| ID  | No | Name    | Power<br>domain | I/O | Description      | Remarks   |
|-----|----|---------|-----------------|-----|------------------|---|
| R7  | 19 | USB_3V3 | USB             | I   | USB supply input | Input for 3.3 V (typical) USB supply.<br>USB interface supported for FW update and diagnostic only.<br>See section 2.5.2 for functional description.<br>See section 4.2.12 for detailed electrical specs.<br>Provide test point for FW update and diagnostic purposes.  |
| R8  | 20 | USB_D-  | USB             | I/O | USB Data Line D- | <ul> <li>90 Ω nominal differential impedance.</li> <li>Pull-up, pull-down and series resistors, as required by the USB 2.0 specifications [10], are part of the USB pin driver and shall not be provided externally.</li> <li>USB interface supported FW update and diagnostic only.</li> <li>See section 2.5.2 for functional description.</li> <li>See section 4.2.12 for detailed electrical specs.</li> <li>Provide test point for FW update and diagnostic purposes.</li> </ul>          |
| R9  | 21 | USB_D+  | USB             | I/O | USB Data Line D+ | <ul> <li>90 Ω nominal differential impedance.</li> <li>Pull-up, pull-down and series resistors, as required by USB</li> <li>2.0 specifications [10], are part of the USB pin driver and shall not be provided externally.</li> <li>USB interface supported for FW update and diagnostic only.</li> <li>See section 2.5.2 for functional description.</li> <li>See section 4.2.12 for detailed electrical specs.</li> <li>Provide test point for FW update and diagnostic purposes.</li> </ul> |
| R10 | 22 | USB_5V0 | USB             | I   | USB detect input | Input for VBUS (5 V typical) USB supply sense.<br>USB interface supported for FW update and diagnostic only.<br>See section 2.5.2 for functional description.<br>See section 4.2.12 for detailed electrical specs.<br>Provide test point for FW update and diagnostic purposes.   |
| R11 | 23 | RSVD    | -               | N/A | Reserved pin     | Leave unconnected.  |
| R12 | 24 | RSVD    | -               | N/A | Reserved pin     | Leave unconnected.  |
| R13 | 25 | RSVD    | -               | N/A | Reserved pin     | Leave unconnected.  |
| R14 | 26 | RSVD    | -               | N/A | Reserved pin     | Leave unconnected.  |
|     |    |         |                 |     |                  |   |

#### Table 6: LEXI-R422 pin-out

- For more information about the pin-out, see the LEXI-R422 system integration manual [2].
- See appendix A for an explanation of the abbreviations and terms used.



## 4 Electrical specifications

- Stressing the device above one or more of the ratings listed in the Absolute Maximum Rating section may cause permanent damage. These are stress ratings only. Operating the module at these or at any conditions other than those specified in the Operating Conditions sections (section 4.2) of the specification should be avoided. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability.
- Electrical characteristics are defined according to the verification on a representative number of samples or according to the simulation.
- TWhere application information is given, it is advisory only and does not form part of the specification.

## 4.1 Absolute maximum rating

🗇 Limiting values given below are in accordance with Absolute Maximum Rating System (IEC 134).

| Symbol  | Description                | Condition   | Min. | Max. | Unit |
|---------|----------------------------|---|------|------|------|
| VCC     | Module supply voltage      | Input DC voltage at VCC pins                        | -0.3 | 6.0  | V    |
| USB_5V0 | USB detection pin          | Input DC voltage at USB_5V0 pin                     | -0.3 | 5.5  | V    |
| USB     | USB D+/D- pins             | Input DC voltage at USB interface pins              | -0.3 | 3.6  | V    |
| GDI     | Generic digital interfaces | Input DC voltage at generic digital interfaces pins | -0.3 | 2.0  | V    |
| 12C     | I2C interface              | Input DC voltage at I2C interface pins              | -0.3 | 2.0  | V    |
| SIM     | SIM interface              | Input DC voltage at SIM interface pins              | -0.3 | 2.0  | V    |
| POS     | Power-on input             | Input DC voltage at PWR_CTRL pin                    | -0.3 | 1.8  | V    |
| ADC     | Antenna detection input    | Input DC voltage at ANT_DET pin                     | -0.3 | 1.8  | V    |
| P_RF    | RF power                   | Input RF power at ANT pin                           |      | 3    | dBm  |
| Rho_ANT | Antenna ruggedness         | Output RF load mismatch ruggedness at ANT pin       |      | 10:1 | VSW  |
| Tstg    | Storage temperature        |   | -40  | +85  | °C   |

Table 7: Absolute maximum ratings

The product is not protected against overvoltage or reversed voltages. If necessary, voltage spikes exceeding the voltage specifications given in the table above, must be limited to values within the specified boundaries by using appropriate protection devices.

#### 4.1.1 Maximum ESD

| Parameter                    | Min | Max  | Unit | Remarks                                       |
|------------------------------|-----|------|------|---|
| ESD sensitivity for all pins |     | 1000 | V    | Human Body Model according to JS-001-2017     |
|                              |     | 500  | V    | Charged Device Model according to JS-002-2018 |

#### Table 8: Maximum ESD ratings

u-blox cellular modules are electrostatic sensitive devices and require special precautions when handling. See section 7.3 for ESD handling instructions.



## 4.2 Operating conditions

- Unless otherwise indicated, all operating condition specifications are at an ambient temperature of +25 °C.
- Operation beyond the operating conditions is not recommended and extended exposure beyond them may affect device reliability.

### 4.2.1 Operating temperature range

| Parameter                       | Min. | Тур. | Max. | Unit | Remarks   |
|---------------------------------|------|------|------|------|---|
| Normal operating<br>temperature | -20  | +25  | +65  | °C   | Operating within 3GPP / ETSI specifications   |
| Extended operating temperature  | -40  |      | +85  | °C   | Operating with possible slight deviation in RF performance outside normal operating range |

Table 9: Environmental conditions

#### 4.2.2 Thermal parameters

| Symbol           | Parameter                              | Min. | Тур. Мах. | Unit | Remarks   |
|------------------|--|------|-----------|------|---|
| Ψ <sub>M-A</sub> | Module-to-Ambient<br>thermal parameter |      | 14        | °C/W | Thermal characterization parameter $\Psi_{M-A} = (T_M - T_A) / P_H$<br>proportional to the difference between the internal temperature<br>sensor of the module ( $T_M$ ) and the ambient temperature ( $T_A$ ),<br>produced by the module heat power dissipation ( $P_H$ ),<br>with the module mounted on a board with roughly 9 x 8 cm size,<br>with still air conditions  |
| Ψ <sub>M-C</sub> | Module-to-Case<br>thermal parameter    |      | 6         | °C/W | Thermal characterization parameter $\Psi_{M-C} = (T_M - T_C) / P_H$<br>proportional to the difference between the internal temperature<br>sensor of the module $(T_M)$ and the ambient temperature $(T_C)$ ,<br>produced by the module heat power dissipation $(P_H)$ ,<br>with the module mounted on a board with roughly 9 x 8 cm size,<br>with forced air ventilation and with a robust aluminum heat-sink,<br>reducing case-to-ambient thermal resistance as much as possible |

Table 10: Thermal characterization parameters of the module

#### 4.2.3 Supply/power pins

| Symbol | Parameter   | Min. | Typical | Max. | Unit |
|--------|---|------|---------|------|------|
| VCC    | Module supply normal operating input voltage <sup>2</sup>   | 3.2  | 3.8     | 4.5  | V    |
|        | Module supply extended operating input voltage <sup>3</sup> | 3.0  |         | 4.5  | V    |

Table 11: Input characteristics of the Supply/Power pins

| Symbol | Parameter   | Min. | Typical | Max. | Unit |
|--------|---|------|---------|------|------|
| VSIM   | SIM supply output voltage with 1.8 V external SIM           |      | 1.8     |      | V    |
| V_INT  | Generic Digital Interfaces supply output voltage            |      | 1.8     |      | V    |
|        | Generic Digital Interfaces supply output current capability |      |         | 70   | mA   |

Table 12: Output characteristics of the Supply/Power pins

<sup>&</sup>lt;sup>2</sup> Operating within 3GPP / ETSI specifications.

<sup>&</sup>lt;sup>3</sup> Operating with possible slight deviation in RF performance outside normal operating range. The input voltage has to be above the extended operating range minimum limit to switch-on the module and to avoid possible switch-off of the module.

 $<sup>^{4}</sup>$  Indicative current consumption values with VCC = 3.8 V



### 4.2.4 Current consumption

| Mode  | Condition   | Tx power | Min | Тур | Max | Unit |
|---|---|----------|-----|-----|-----|------|
| Power Off Mode<br>(module switched off)   | Averaged current  |          |     | 3   |     | μA   |
| PSM Deep Sleep Mode   | Averaged current  |          |     | 3   |     | μA   |
| Low Power Mode<br>(+UPSV: 4)  | Floor current<br>(deep sleep in between eDRX cycles)                  |          |     | 3   |     | μA   |
|   | Floor current<br>(no deep sleep in between eDRX cycles)               |          |     | 0.4 |     | mA   |
|   | Averaged current<br>(deep sleep in between eDRX cycle of 655.36 s)    |          |     | 0.1 |     | mA   |
|   | Averaged current<br>(no deep sleep in between eDRX cycle of 655.36 s) |          |     | 0.5 |     | mA   |
|   | Averaged current<br>(no deep sleep in between eDRX cycle of 20.48 s)  |          |     | 0.6 |     | mA   |
|   | Averaged current<br>(2G DRX cycle of 1.2 s)                           |          |     | 1.2 |     | mA   |
| Active Mode<br>(Power Saving / Low Power Mode<br>disabled, registered with network) | Averaged current  |          |     | 9   |     | mA   |
| LTE NB-IoT Connected Mode   | Averaged current during Tx / Rx                                       | Minimum  |     | 65  |     | mA   |
| (Data Tx / Rx)  |   | Maximum  |     | 230 |     | mA   |
|   | Peak current during Tx  | Maximum  |     |     | 0.8 | А    |
| LTE Cat M1 Connected Mode   | Averaged current during Tx / Rx                                       | Minimum  |     | 105 |     | mA   |
| (Data Tx / Rx)  |   | Maximum  |     | 350 |     | mA   |
|   | Peak current value during Tx  | Maximum  |     |     | 0.8 | А    |
| 2G Connected Mode<br>(Data Tx / Rx)   | Averaged current value during GMSK 1-Tx/1-Rx call 850/900 MHz bands   | Maximum  |     | 250 |     | mA   |
|   | Peak current value during GMSK 1-slot Tx,<br>850/900 MHz bands        | Maximum  |     | 1.9 | 2.5 | A    |

Table 13: VCC current consumption of the LEXI-R422 module<sup>4</sup>

### 4.2.5 LTE RF characteristics

The LTE Cat M1 / NB2 bands supported by LEXI-R422 modules are defined in Table 2, while Table 14 describes the frequency ranges for each LTE band as per 3GPP TS 36.521-1 [7].

| Parameter             |          | Min. | Max. | Unit | Remarks          |
|-----------------------|----------|------|------|------|------------------|
| Frequency range       | Uplink   | 698  | 716  | MHz  | Module transmits |
| FDD band 85 (700 MHz) | Downlink | 728  | 746  | MHz  | Module receives  |
| Frequency range       | Uplink   | 699  | 716  | MHz  | Module transmits |
| FDD band 12 (700 MHz) | Downlink | 729  | 746  | MHz  | Module receives  |
| Frequency range       | Uplink   | 703  | 748  | MHz  | Module transmits |
| FDD band 28 (700 MHz) | Downlink | 758  | 803  | MHz  | Module receives  |
| Frequency range       | Uplink   | 777  | 787  | MHz  | Module transmits |
| FDD band 13 (750 MHz) | Downlink | 746  | 756  | MHz  | Module receives  |
| Frequency range       | Uplink   | 832  | 862  | MHz  | Module transmits |
| FDD band 20 (800 MHz) | Downlink | 791  | 821  | MHz  | Module receives  |

 $^{\rm 4}$  Indicative current consumption values with VCC = 3.8 V



| Parameter              |          | Min. | Max. | Unit | Remarks          |
|------------------------|----------|------|------|------|------------------|
| Frequency range        | Uplink   | 814  | 849  | MHz  | Module transmits |
| FDD band 26 (850 MHz)  | Downlink | 859  | 894  | MHz  | Module receives  |
| Frequency range        | Uplink   | 815  | 830  | MHz  | Module transmits |
| FDD band 18 (850 MHz)  | Downlink | 860  | 875  | MHz  | Module receives  |
| Frequency range        | Uplink   | 824  | 849  | MHz  | Module transmits |
| FDD band 5 (850 MHz)   | Downlink | 869  | 894  | MHz  | Module receives  |
| Frequency range        | Uplink   | 830  | 845  | MHz  | Module transmits |
| FDD band 19 (850 MHz)  | Downlink | 875  | 890  | MHz  | Module receives  |
| Frequency range        | Uplink   | 880  | 915  | MHz  | Module transmits |
| FDD band 8 (900 MHz)   | Downlink | 925  | 960  | MHz  | Module receives  |
| Frequency range        | Uplink   | 1710 | 1755 | MHz  | Module transmits |
| FDD band 4 (1700 MHz)  | Downlink | 2110 | 2155 | MHz  | Module receives  |
| Frequency range        | Uplink   | 1710 | 1780 | MHz  | Module transmits |
| FDD band 66 (1700 MHz) | Downlink | 2110 | 2200 | MHz  | Module receives  |
| Frequency range        | Uplink   | 1710 | 1785 | MHz  | Module transmits |
| FDD band 3 (1800 MHz)  | Downlink | 1805 | 1880 | MHz  | Module receives  |
| Frequency range        | Uplink   | 1850 | 1910 | MHz  | Module transmits |
| FDD band 2 (1900 MHz)  | Downlink | 1930 | 1990 | MHz  | Module receives  |
| Frequency range        | Uplink   | 1850 | 1915 | MHz  | Module transmits |
| FDD band 25 (1900 MHz) | Downlink | 1930 | 1995 | MHz  | Module receives  |
| Frequency range        | Uplink   | 1920 | 1980 | MHz  | Module transmits |
| FDD band 1 (2100 MHz)  | Downlink | 2110 | 2170 | MHz  | Module receives  |
|                        |          |      |      |      |                  |

Table 14: LTE operating RF frequency bands

LEXI-R422 modules include a UE Power Class 3 LTE Cat M1 / NB2 transmitter (see Table 2) and an LTE receiver, with output power and characteristics according to 3GPP TS 36.521-1 [7].

The LEXI-R422 module's LTE receiver characteristics are compliant to 3GPP TS 36.521-1 [7], with LTE conducted receiver sensitivity performance described in Table 15 and Table 16.

| Parameter  | Min. | Typical | Max. | Unit | Remarks             |
|--|------|---------|------|------|---------------------|
| Receiver input sensitivity<br>Band 12/28/85 (700 MHz)        |      | -108.5  |      | dBm  | Without repetitions |
| Receiver input sensitivity<br>Band 13 (750 MHz)              |      | -108.5  |      | dBm  | Without repetitions |
| Receiver input sensitivity<br>Band 20 (800 MHz)              |      | -108.0  |      | dBm  | Without repetitions |
| Receiver input sensitivity<br>Band 5 / 18 / 19 / 26 (850 MH: | z)   | -108.0  |      | dBm  | Without repetitions |
| Receiver input sensitivity<br>Band 8 (900 MHz)               |      | -107.5  |      | dBm  | Without repetitions |
| Receiver input sensitivity<br>Band 3 (1800 MHz)              |      | -108.0  |      | dBm  | Without repetitions |
| Receiver input sensitivity<br>Band 2 / 25 (1900 MHz)         |      | -108.0  |      | dBm  | Without repetitions |
| Receiver input sensitivity<br>Band 1 / 4 / 66 (2100 MHz)     |      | -108.0  |      | dBm  | Without repetitions |

Condition: 50  $\Omega$  source, throughput > 95%, QPSK modulation, other settings as per clause 7.3EA of 3GPP TS 36.521-1 [7]

Table 15: LTE Cat M1 receiver sensitivity performance



| Parameter   | Min. | Typical | Max. | Unit | Remarks             |  |
|---|------|---------|------|------|---------------------|--|
| Receiver input sensitivity<br>Band 12/28/85 (700 MHz)       |      | -116.5  |      | dBm  | Without repetitions |  |
| Receiver input sensitivity<br>Band 13 (750 MHz)             |      | -116.5  |      | dBm  | Without repetitions |  |
| Receiver input sensitivity<br>Band 20 (800 MHz)             |      | -116.0  |      | dBm  | Without repetitions |  |
| Receiver input sensitivity<br>Band 5 / 18 / 19 / 26 (850 MH | Hz)  | -116.0  |      | dBm  | Without repetitions |  |
| Receiver input sensitivity<br>Band 8 (900 MHz)              |      | -116.0  |      | dBm  | Without repetitions |  |
| Receiver input sensitivity<br>Band 3 (1800 MHz)             |      | -116.0  |      | dBm  | Without repetitions |  |
| Receiver input sensitivity<br>Band 2 / 25 (1900 MHz)        |      | -116.0  |      | dBm  | Without repetitions |  |
| Receiver input sensitivity<br>Band 1 / 4 / 66 (2100 MHz)    |      | -116.0  |      | dBm  | Without repetitions |  |

Condition: 50 Ω source, throughput > 95%, QPSK modulation, other settings as per clause 7.3F of 3GPP TS 36.521-1 [7]

Table 16: LTE Cat NB2 receiver sensitivity performance

#### 4.2.6 2G RF characteristics

The 2G bands supported by LEXI-R422 modules are defined in the Table 2, while the following Table 17 describes the Transmitting and Receiving frequencies according to 3GPP TS 51.010-1 [8].

| Parameter       |          | Min  | Max  | Unit | Remarks          |
|-----------------|----------|------|------|------|------------------|
| Frequency range | Uplink   | 824  | 849  | MHz  | Module transmits |
| GSM 850         | Downlink | 869  | 894  | MHz  | Module receives  |
| Frequency range | Uplink   | 880  | 915  | MHz  | Module transmits |
| E-GSM 900       | Downlink | 925  | 960  | MHz  | Module receives  |
| Frequency range | Uplink   | 1710 | 1785 | MHz  | Module transmits |
| DCS 1800        | Downlink | 1805 | 1880 | MHz  | Module receives  |
| Frequency range | Uplink   | 1850 | 1910 | MHz  | Module transmits |
| PCS 1900        | Downlink | 1930 | 1990 | MHz  | Module receives  |

Table 17: 2G operating RF frequency bands

LEXI-R422 modules include a GMSK Power Class 4 transmitter for the GSM 850 and E-GSM 900 bands, a GMSK Power Class 1 transmitter for the DCS 1800 and PCS 1900 bands, a 8-PSK Power Class E2 transmitter for all the 2G bands (see Table 2), with output power and characteristics according to 3GPP TS 51.010-1 [8].

LEXI-R422 modules 2G receiver characteristics are compliant to 3GPP TS 51.010-1 [8], with conducted receiver sensitivity performance described in Table 18.

| Parameter                            | Min | Typical | Max | Unit | Remarks                                  |
|--------------------------------------|-----|---------|-----|------|--|
| GSM 850 receiver input sensitivity   |     | -109    |     | dBm  | Downlink RF level @ BER Class II < 2.4 % |
| E-GSM 900 receiver input sensitivity |     | -109    |     | dBm  | Downlink RF level @ BER Class II < 2.4 % |
| DCS 1800 receiver input sensitivity  |     | -109    |     | dBm  | Downlink RF level @ BER Class II < 2.4 % |
| PCS 1900 receiver input sensitivity  |     | -109    |     | dBm  | Downlink RF level @ BER Class II < 2.4 % |

Condition: 50  $\Omega$  source

#### Table 18: 2G receiver sensitivity performance



#### 4.2.7 ANT\_DET pin

|  | 71  | Unit F | Remarks |
|--|-----|--------|---------|
| ANT_DET Output DC current pulse value 35 | 5   | μA     |         |
| Output DC current pulse time length 11   | 160 | μs     |         |

Table 19: ANT\_DET pin characteristics

#### 4.2.8 PWR\_CTRL pin

| Parameter                                    | Min.  | Typical | Max. | Unit | Remarks  |
|--|-------|---------|------|------|--|
| Internal supply for<br>PWR_CTRL Input Signal |       | 1.5     |      | V    | The PWR_CTRL input is pulled up to an internal voltage rail. |
| Low-level input                              | -0.30 |         | 0.35 | V    |  |
| PWR_CTRL low time                            | 0.01  |         | 12.0 | S    | Low time to trigger module switch on from power off mode     |
|  | 0.01  |         | 12.0 | S    | Low time to trigger module wake-up from PSM deep sleep       |
|  | 1.10  |         | 14.0 | S    | Low time to trigger module graceful switch off               |
|  | 16.0  |         |      | S    | Low time to trigger module abrupt emergency reset (reboot)   |

Table 20: PWR\_CTRL pin characteristics

#### 4.2.9 SIM pins

The SIM pins are a dedicated interface to the external SIM card/chip. The electrical characteristics fulfill the regulatory specification requirements. The values in Table 21 are for information only.

| Parameter                                | Min. | Typical | Max. | Unit | Remarks                            |
|--|------|---------|------|------|------------------------------------|
| Internal supply domain for SIM interface |      | 1.8     |      | V    | VSIM, with external 1.8 V SIM type |
| Low-level input                          | -0.3 |         | 0.4  | V    |                                    |
| High-level input                         | 1.1  |         | 2.0  | V    |                                    |
| Low-level output                         |      | 0.0     |      | V    |                                    |
| High-level output                        |      | 1.8     |      | V    |                                    |
| Internal pull-up resistor on SIM_IO      |      | 4.7     |      | kΩ   | Internal pull-up to VSIM supply    |
| Clock frequency on SIM_CLK               |      | 4.8     |      | MHz  |                                    |
|  |      |         |      |      |                                    |

Table 21: SIM pins characteristics

#### 4.2.10 I2C pins

I2C lines (**SCL** and **SDA**) are compliant to the I2C-bus standard mode specification. See the I2C-bus specification [11] for detailed electrical characteristics.

| Parameter                      | Min  | Typical | Max | Unit | Remarks                               |
|--------------------------------|------|---------|-----|------|---------------------------------------|
| Internal supply for I2C domain |      | 1.8     |     | V    | Digital I/O Interfaces supply (V_INT) |
| Low-level input                | -0.3 |         | 0.5 | V    |                                       |
| High-level input               | 1.3  |         | 2.1 | V    |                                       |
| Low-level output               |      | 0.0     |     | V    |                                       |
| Internal pull-up resistance    |      | 2.2     |     | kΩ   |                                       |

Table 22: I2C pins characteristics



#### 4.2.11 Generic Digital Interfaces pins

| Parameter                               | Min  | Typical | Max | Unit | Remarks                               |
|---|------|---------|-----|------|---------------------------------------|
| Internal supply for GDI domain          |      | 1.8     |     | V    | Digital I/O Interfaces supply (V_INT) |
| Low-level input                         | -0.3 |         | 0.6 | V    |                                       |
| High-level input                        | 1.2  |         | 2.0 | V    |                                       |
| Low-level output                        |      | 0.0     | 0.4 | V    | Max value at IOL = +2.0 mA            |
| High-level output                       | 1.4  | 1.8     |     | V    | Min value at IOH = -2.0 mA            |
| Internal pull-up / pull-down resistance | 55   |         | 390 | kΩ   |                                       |

Table 23: GDI pins characteristics

#### 4.2.12 USB pins

USB data lines (**USB\_D+** / **USB\_D-**) are compliant with the USB 2.0 high-speed specification. See the Universal Serial Bus specification revision 2.0 [10] for detailed electrical characteristics. The values in Table 24 related to USB 2.0 high-speed physical layer specifications are for information only.

| Parameter   | Min. | Typical | Max. | Unit | Remarks                                 |
|---|------|---------|------|------|---|
| Input voltage on pin USB_5V0  | 4.40 | 5.00    | 5.25 | V    | Sense input to enable the USB interface |
| Input voltage on pin USB_3V3  |      | 3.30    |      | V    | Supply input for the USB interface      |
| High-speed squelch detection threshold<br>(input differential signal amplitude) | 100  |         | 150  | mV   |   |
| High speed disconnect detection threshold (input differential signal amplitude) | 525  |         | 625  | mV   |   |
| High-speed data signaling input common mode voltage range                       | -50  |         | 500  | mV   |   |
| High-speed idle output level  | -10  |         | 10   | mV   |   |
| High-speed data signaling output high level                                     | 360  |         | 440  | mV   |   |
| High-speed data signaling output low level                                      | -10  |         | 10   | mV   |   |
| Chirp J level (output differential voltage)                                     | 700  |         | 1100 | mV   |   |
| Chirp K level (output differential voltage)                                     | -900 |         | -500 | mV   |   |

Table 24: USB pins characteristics



## 5 Mechanical specifications

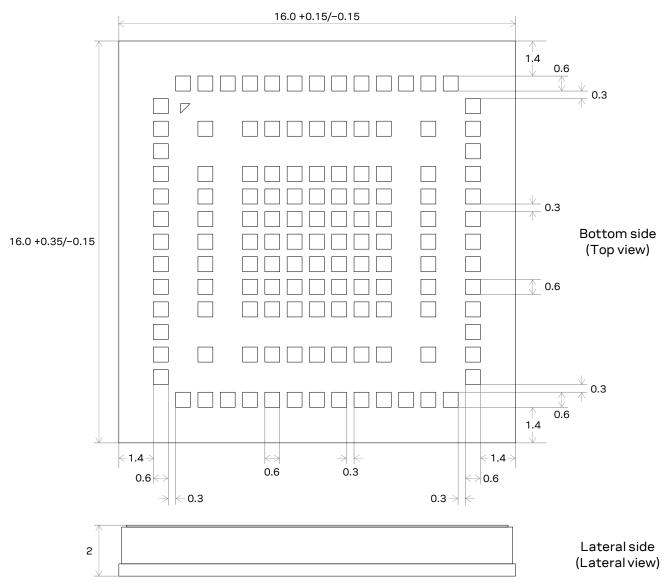


Figure 3: LEXI-R422 dimensions, typical values [mm]

- Actual geometries of the pads may depend on related implementation of the solder resist mask openings and the underlying copper layer.
- For information regarding Footprint and Stencil design recommended for the application board integrating the cellular module, see the LEXI-R422 system integration manual [2].



## 6 Qualification and approvals

## 6.1 Reliability tests

Reliability tests for LEXI-R422 modules are executed according to u-blox qualification policy, based on AEC-Q104 standard.

## 6.2 Approvals

LEXI-R422 modules comply with the Directive 2011/65/EU of the European Parliament and the Council on the Restriction of Use of certain Hazardous Substances in Electrical and Electronic Equipment (EU RoHS 2) and its amendment Directive (EU) 2015/863 (EU RoHS 3).

LEXI-R422 modules are RoHS 3 compliant.

No natural rubbers, hygroscopic materials, or materials containing asbestos are employed.

 Table 25 summarizes the main approvals planned for LEXI-R422 modules.

| Certification            | LEXI-R422       |
|--------------------------|-----------------|
| PTCRB                    | ٠               |
| GCF                      | •               |
| E Europe                 | •               |
| CC United Sates          | •               |
| CC ID                    | XPYUBX22VA03    |
| SED Canada               | •               |
| ED Certification Number  | 8595A-UBX22VA03 |
| CC Taiwan                | •               |
| CC Certificate Number    | CCAF24Y00090T2  |
| NATEL Brazil             | •               |
| NATEL Certificate Number | 22317-23-05903  |
| CMA RCM Australia        | •               |
| odafone                  | •               |
| eutsche Telekom          | •               |

Table 25: LEXI-R422 main certification approvals summary

For guidelines and notices about compliance with the various certification approvals requirements integrating LEXI-R422 modules in host devices, see the system integration manual [2].

For the complete list of achieved or planned approvals, and for specific details on all country, conformance and network operators' certifications available for the LEXI-R422 modules, including related certificates, please contact your nearest u-blox office or sales representative.



## 7 Product handling & soldering

## 7.1 Packaging

LEXI-R422 modules are delivered as hermetically sealed, reeled tapes to enable efficient production, production lot set-up and tear-down. For more information about packaging, see the u-blox package information user guide [3].

### 7.1.1 Reels

LEXI-R422 modules are deliverable in quantities of 500 pieces on a reel. The modules are delivered using reel type A4 described in the u-blox package information user guide [3].

Quantities of less than 500 pieces are also available. Contact u-blox for more information.

### 7.1.2 Tapes

LEXI-R422 modules are delivered on the tape illustrated in Figure 5, while Figure 4 shows the position and the orientation of the modules on the tape.

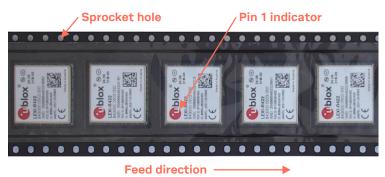


Figure 4: Orientation of LEXI-R422 modules on tape

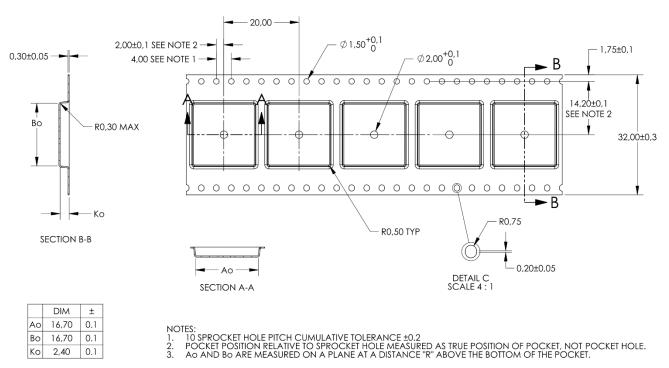


Figure 5: LEXI-R422 modules tape (all dimensions in millimeters)



### 7.2 Moisture sensitivity levels

▲ LEXI-R422 modules are moisture sensitive devices (MSD) in accordance to the related IPC/JEDEC specifications.

The Moisture Sensitivity Level (MSL) relates to the packaging and handling precautions required. LEXI-R422 modules are rated at MSL level 4. For more information regarding moisture sensitivity levels, labeling, storage and drying, see the u-blox package information user guide [3].

For the MSL standard, see IPC/JEDEC J-STD-020 (can be downloaded from www.jedec.org).

## 7.3 ESD precautions

LEXI-R422 modules contain highly sensitive electronic circuitry and are Electrostatic Sensitive Devices (ESD). Handling LEXI-R422 modules without proper ESD protection may destroy or damage them permanently.



Ensure ESD precautions are implemented during handling of the module.

Electrostatic discharge (ESD) is the sudden and momentary electric current that flows between two objects at different electrical potentials caused by direct contact or induced by an electrostatic field. The term is usually used in the electronics and other industries to describe momentary unwanted currents that may cause damage to electronic equipment.

Table 8 details the maximum ESD ratings of the LEXI-R422 modules.

Proper ESD handling and packaging procedures must be applied throughout the processing, handling and operation of any application that incorporates LEXI-R422 modules.

ESD precautions should be appropriately implemented on the application board where the module is mounted, as described in the LEXI-R422 system integration manual [2].

A Failure to observe these precautions can result in severe damage to the device!

### 7.4 Reflow soldering

Reflow profiles are to be selected according to u-blox recommendations, as illustrated in details in the system integration manual [2].

A Failure to observe these recommendations can result in severe damage to the device!



## 8 Labeling and ordering information

## 8.1 Product labeling

The labels of LEXI-R422 modules include important product information, as described in this section. Figure 6 provides an illustrative example of LEXI-R422 modules' label, which includes for example: the u-blox logo (acting also as pin 1 indicator), production date, Pb-free marking, product type number, IMEI number, certification info, and production country of the module.



Figure 6: Illustrative example of LEXI-R422 modules' label

## 8.2 Explanation of codes

Three different product code formats are used. The **Product name** is used in documentation such as this data sheet and identifies all the u-blox products, independent of packaging and quality grade. The **Ordering code** includes options and quality, while the **Type number** includes the hardware and firmware versions. Table 26 details these 3 different formats:

| Format        | Structure        |
|---------------|------------------|
| Product name  | PPPP-TGVV        |
| Ordering code | PPPP-TGVV-MMQ    |
| Type number   | PPPP-TGVV-MMQ-XX |

Table 26: Product code formats

#### Table 27 explains the parts of the product code.

| Code | Meaning   | Example           |
|------|---|-------------------|
| PPPP | Form factor   | LEXI              |
| TG   | <ul> <li>Platform (Technology and Generation)</li> <li>Dominant technology: G = GSM, U = UMTS, C = CDMA, N = NB-IoT (LTE Cat NB1/NB2),<br/>R = LTE low data rate (Cat M1, Cat 1, Cat 1bis), L = LTE high data rate (Cat 3 and above)</li> <li>Generation: 19</li> </ul> | R4                |
| VV   | Variant function set based on the same platform: 0099   | 22                |
| MM   | Major product version: 0099   | 01                |
| Q    | Product grade: C = standard, B = professional, A = automotive   | В                 |
| XX   | Minor product version: 0099   | Default value: 00 |
|      |   |                   |

Table 27: Part identification code

## 8.3 Ordering information

| Ordering No.  | Product   |
|---------------|---|
| LEXI-R422-01B | LTE Cat M1 / NB2 and 2G module.<br>16.0 x 16.0 mm |

Table 28: Product ordering codes



## Appendix

## A Glossary

| Abbreviation | Definition   |
|--------------|--|
| 3GPP         | 3 <sup>rd</sup> Generation Partnership Project                                     |
| 8-PSK        | 8 Phase-Shift Keying modulation  |
| ACMA         | Australian Communications and Media Authority                                      |
| ADC          | Analog to Digital Converter  |
| ANATEL       | Agência Nacional de Telecomunicações - National Telecommunications Agency (Brazil) |
| Cat          | Category   |
| CE           | European Conformity  |
| CLK          | Clock  |
| CMOS         | Complementary Metal-Oxide-Semiconductor  |
| CoAP         | Constrained Application Protocol   |
| CTS          | Clear To Send  |
| DC           | Direct Current   |
| DCD          | Data Carrier Detect  |
| DL           | Down Link (Reception)  |
| DRX          | Discontinuous Reception  |
| DSR          | Data Set Ready   |
| DTE          | Data Terminal Equipment  |
| DTLS         | Datagram Transport Layer Security  |
| DTR          | Data Terminal Ready  |
| eDRX         | Extended Discontinuous Reception   |
| ESD          | Electrostatic Discharge  |
| E-UTRA       | Evolved Universal Terrestrial Radio Access   |
| FCC          | Federal Communications Commission United States                                    |
| FDD          | Frequency Division Duplex  |
| FOAT         | Firmware (update) Over AT commands   |
| FOTA         | Firmware (update) Over-The-Air   |
| FTP          | File Transfer Protocol   |
| GCF          | Global Certification Forum   |
| GDI          | Generic Digital Interface  |
| GND          | Ground   |
| GNSS         | Global Navigation Satellite System   |
| GMSK         | Gaussian Minimum-Shift Keying modulation   |
| GPIO         | General Purpose Input/Output   |
| HDLC         | High-level Data Link Control   |
| HTTP         | HyperText Transfer Protocol  |
| ID           | Identifier   |
| 12C          | Inter-Integrated Circuit   |
| 125          | Inter-IC Sound   |
| I/O          | Input/Output   |
| IMEI         | International Mobile Equipment Identity  |
| ISED         | Innovation, Science and Economic Development Canada                                |



| Abbreviation | Definition  |
|--------------|---|
| LGA          | Land Grid Array   |
| LPWA         | Low Power Wide Area   |
| LTE          | Long-Term Evolution   |
| LTE-M        | Long-Term Evolution – enhanced Machine Type Communication (LTE Category M1) |
| LwM2M        | Lightweight Machine-to-Machine protocol                                     |
| M2M          | Machine to Machine  |
| MQTT         | Message Queuing Telemetry Transport   |
| MQTT-SN      | Message Queuing Telemetry Transport for Sensor Networks                     |
| N/A          | Not Applicable  |
| NB-IoT       | Narrowband Internet of Things (LTE Category NB1 / LTE Category NB2)         |
| NCC          | National Communications Commission Taiwan                                   |
| No           | Number  |
| PCN          | Product Change Notification / Sample Delivery Note / Information Note       |
| PMU          | Power Management Unit   |
| POS          | Power On Signal   |
| PSM          | Power Saving Mode   |
| PTCRB        | PCS Type Certification Review Board   |
| QPSK         | Quadrature Phase Shift Keying modulation                                    |
| RAT          | Radio Access Technology   |
| RCM          | Regulatory Compliance Mark (Australia)                                      |
| RED          | Radio Equipment Directive (European Union)                                  |
| RF           | Radio Frequency   |
| RI           | Ring Indicator  |
| RIL          | Radio Interface Layer   |
| RTC          | Real Time Clock   |
| RTS          | Request To Send   |
| Rx           | Reception   |
| SCL          | Serial Clock  |
| SDA          | Serial Data   |
| SIM          | Subscriber Identity Module  |
| SSL          | Secure Socket Layer   |
| ТСР          | Transmission Control Protocol   |
| TLS          | Transport Layer Security  |
| TS           | Technical Specification   |
| Тх           | Transmission  |
| UART         | Universal Asynchronous Receiver/Transmitter                                 |
| UDP          | User Datagram Protocol  |
| UE           | User Equipment  |
| uFOTA        | u-blox Firmware (update) Over-The-Air                                       |
| UKCA         | United Kingdom Conformity Assessed  |
| UL           | Uplink (Transmission)   |
| VSWR         | Voltage Standing Wave Ratio   |



## **Related documentation**

- [1] u-blox LEXI-R422 / SARA-R4 series AT commands manual, UBX-17003787
- [2] u-blox LEXI-R422 system integration manual, UBX-23007449
- [3] u-blox package information user guide, UBX-14001652
- [4] 3GPP TS 27.007 AT command set for User Equipment (UE)
- [5] 3GPP TS 27.005 Use of Data Terminal Equipment Data Circuit terminating Equipment (DTE – DCE) interface for Short Message Service (SMS) and Cell Broadcast Service (CBS)
- [6] 3GPP TS 27.010 Terminal Equipment to User Equipment (TE-UE) multiplexer protocol
- [7] 3GPP TS 36.521-1 Evolved Universal Terrestrial Radio Access; User Equipment conformance specification; Radio transmission and reception; Part 1: Conformance Testing
- [8] 3GPP TS 51.010-1 Mobile Station conformance specification; part 1: conformance specification
- [9] ITU-T Recommendation V24 List of definitions for interchange circuits between Data Terminal Equipment (DTE) and Data Connection Equipment (DCE)
- [10] Universal Serial Bus Revision 2.0 specification, https://www.usb.org/
- [11] I2C-bus specification and user manual UM10204 NXP semiconductors, https://www.nxp.com/docs/en/user-guide/UM10204.pdf
- [12] RFC 7252 Constrained Application Protocol (CoAP)

For regular updates to u-blox documentation and to receive product change notifications, register on our homepage (www.u-blox.com).

## **Revision history**

| Revision | Date        | Name | Comments   |
|----------|-------------|------|--|
| R01      | 23-May-2023 | sses | Initial release  |
| R02      | 30-Jun-2023 | sses | Updated LEXI-R422-01B product status to prototype.<br>Minor corrections and clarifications.  |
| R03      | 06-Oct-2023 | SSES | Updated LEXI-R422-01B product status to engineering sample.<br>Added memory-safe emergency power-off function.<br>Minor other corrections and clarifications.                                      |
| R04      | 22-Jul-2024 | SSES | Updated LEXI-R422-01B product status to initial production.<br>Added thermal parameters, certification info and orientation of the modules on tape.<br>Minor other corrections and clarifications. |

## Contact

u-blox AG

Address: Zürcherstrasse 68 8800 Thalwil Switzerland

For further support and contact information, visit us at www.u-blox.com/support.

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